**Vishay Semiconductors** 



### **FEATURES**

- Package type: surface-mount
- · Package form: top view
- Dimensions (L x W x H in mm): 5 x 4 x 0.9
- Radiant sensitive area (in mm<sup>2</sup>): 7.5
- Supression filter for infrared radiation
- · Fast response times
- Angle of half sensitivity:  $\phi = \pm 65^{\circ}$
- Floor life: 72 h, MSL 4, according to J-STD-020
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Wearables
- · Optical heart rate monitoring
- Ambient light sensors

# **PRODUCT SUMMARY**

VEMD5510CF is a high speed and high sensitive PIN

photodiode. It is a low profile surface-mount device (SMD)

including the chip with a 7.5 mm<sup>2</sup> sensitive area detecting visible light much like the human eye. The diode has its

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COMPONENT	I <sub>ra</sub> (μΑ)	φ <b>(°)</b>	λ <sub>0.5</sub> (nm)
VEMD5510CF	0.25	± 65	440 to 620

Note

DESCRIPTION

Test conditions see table "Basic Characteristics"

peak sensitivity at 540 nm and a low capacitance.

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VEMD5510CF	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Top view		
VEMD5510CF-GS15	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	Top view		

#### Note

· MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V <sub>R</sub>	20	V
Power dissipation	T <sub>amb</sub> ≤25 °C	Pv	215	mW
Junction temperature		Тj	110	°C
Operating temperature range		T <sub>amb</sub>	-40 to +100	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Soldering temperature	According to reflow solder profile Fig. 8	T <sub>sd</sub>	260	°C
Thermal resistance junction-to-ambient		R <sub>thJA</sub>	350	K/W
ESD safety HBM	$\pm$ 2000 V, 1.5 kΩ, 100 pF, 3 pulses	ESD <sub>HBM</sub>	≥ 2	kV



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<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 50 mA	V <sub>F</sub>	-	0.9	1.3	V
Breakdown voltage	I <sub>R</sub> = 100 μA, E = 0	V <sub>(BR)</sub>	20	-	-	V
Reverse dark current	V <sub>R</sub> = 10 V, E = 0	I <sub>ro</sub>	-	0.2	10	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	80	-	pF
	V <sub>R</sub> = 3 V, f = 1 MHz, E = 0	CD	-	30	40	pF
Open circuit voltage	E <sub>V</sub> = 100 lx, CIE illuminant A	Vo	-	210	-	mV
Temperature coefficient of Vo	E <sub>V</sub> = 100 lx, CIE illuminant A	TK <sub>Vo</sub>	-	-2.3	-	mV/K
Short circuit current	E <sub>V</sub> = 100 lx, CIE illuminant A	I <sub>k</sub>	-	0.25	-	μA
Reverse light current	$E_e = 0.2 \text{ mW/cm}^2$ , $\lambda = 525 \text{ nm}$ , $V_R = 5 \text{ V}$	I <sub>ra</sub>	1.35	2.1	3.05	μA
	$E_V = 100 \text{ lx}, \text{ CIE illuminant A}, V_R = 5 \text{ V}$	I <sub>ra</sub>	0.16	0.25	0.39	μA
Angle of half sensitivity		φ	-	± 65	-	0
Wavelength of peak sensitivity		λρ	-	540	-	nm
Range of spectral bandwidth		λ <sub>0.5</sub>	-	440 to 620	-	nm
Rise time	$V_R$ = 5 V, $R_L$ = 50 $\Omega$ , $\lambda$ = 525 nm	t <sub>r</sub>	-	40	-	ns
Fall time	$V_R$ = 5 V, $R_L$ = 50 $\Omega$ , $\lambda$ = 525 nm	t <sub>f</sub>	-	30	-	ns

BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

Basic characteristics graphs to be extended to 110 °C ambient temperatures where applicable.

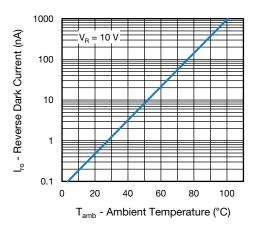


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

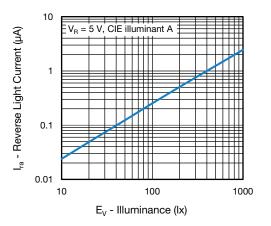
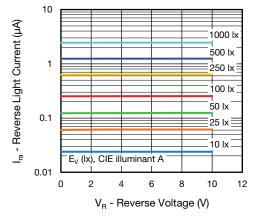


Fig. 2 - Reverse Light Current vs. Irradiance

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Fig. 3 - Reverse Light Current vs. Reverse Voltage

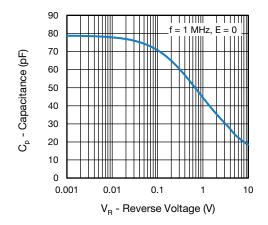


Fig. 4 - Diode Capacitance vs. Reverse Voltage

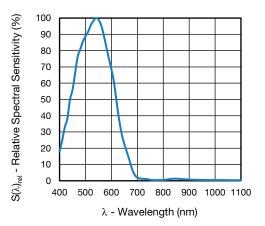


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

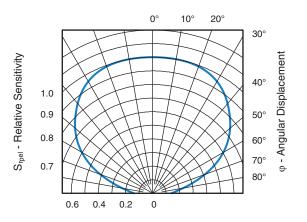
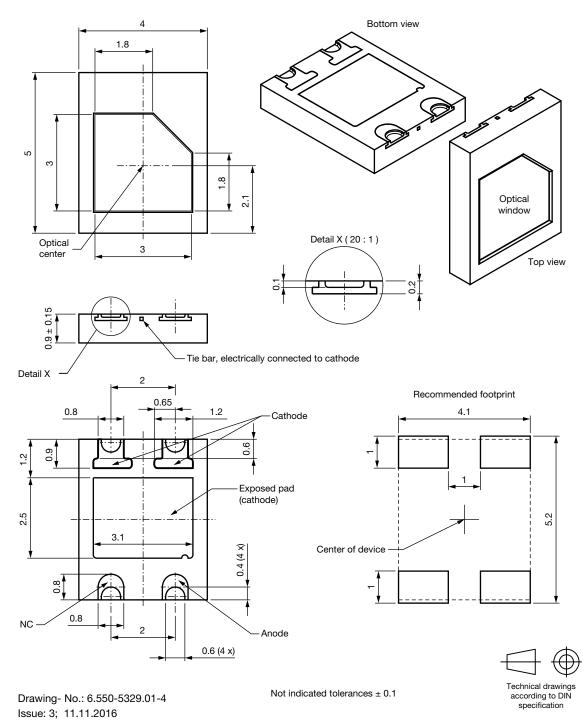


Fig. 6 - Relative Sensitivity vs. Angular Displacement



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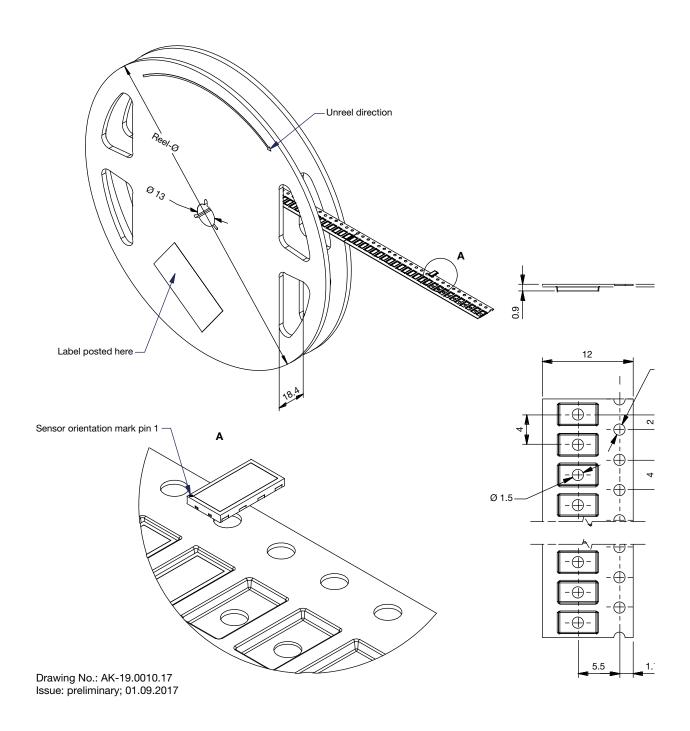
### **PACKAGE DIMENSIONS** in millimeters





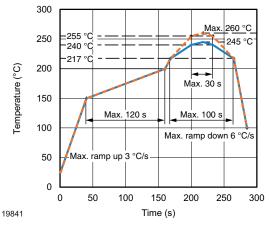
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#### TAPE AND REEL DIMENSIONS in millimeters

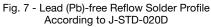


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### SOLDER PROFILE



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#### DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

### FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions:  $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$ 

#### DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %.



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